Vishay Semiconductors

High Speed Infrared Emitting Diodes, 940 nm, Surface Emitter Technology



www.vishay.com

DESCRIPTION

As part of the <u>SurfLight</u>^{IM} portfolio, the VSMY2940 series are infrared, 940 nm emitting diodes based on GaAlAs surface emitter chip technology with extreme high radiant intensities, high optical power and high speed, molded in clear, untinted plastic packages (with lens) for surface mounting (SMD).

APPLICATIONS

- Miniature light barrier
- Photointerrupters
- · Optical switch
- Emitter source for proximity sensors

FEATURES

- Package type: surface-mount
- Package form: GW, RGW
- Dimensions (L x W x H in mm): 2.3 x 2.3 x 2.8
- Peak wavelength: $\lambda_p = 940 \text{ nm}$
- AEC-Q101 qualified
- · High radiant power
- · Very high radiant intensity
- Angle of half intensity: $\varphi = \pm 10^{\circ}$
- Suitable for high pulse current operation
- Terminal configurations: gullwing or reverse gullwing
- Package matches with detector VEMD2000X01 series
- Floor life: 4 weeks, MSL 2a, according to J-STD-020
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

PRODUCT SUMMARY				
COMPONENT	l _e (mW/sr)	φ (deg)	λ _P (nm)	t _r (ns)
VSMY2940RGX01	145	± 10	940	10
VSMY2940GX01	145	± 10	940	10

Note

• Test conditions see table "Basic Characteristics"

ORDERING INFORMATION				
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM	
VSMY2940RGX01	Tape and reel	MOQ: 6000 pcs, 6000 pcs/reel	Reverse gullwing	
VSMY2940GX01	Tape and reel	MOQ: 6000 pcs, 6000 pcs/reel	Gullwing	

Note

• MOQ: minimum order quantity

1 For technical questions, contact: <u>emittertechsupport@vishay.com</u>





COMPLIANT HALOGEN FREE GREEN

(5-2008)



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ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25 \text{ °C}$, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage		V _R	5	V
Forward current		I _F	100	mA
Peak forward current	$t_p/T = 0.5, t_p = 100 \ \mu s$	I _{FM}	200	mA
Surge forward current	t _p = 100 μs	I _{FSM}	1	A
Power dissipation		Pv	170	mW
Junction temperature		Tj	100	°C
Operating temperature range		T _{amb}	-40 to +85	°C
Storage temperature range		T _{stg}	-40 to +100	°C
Soldering temperature	According to Fig. 10, J-STD-020	T _{sd}	260	°C
Thermal resistance junction-to-ambient	J-STD-051, soldered on PCB	R _{thJA}	250	K/W

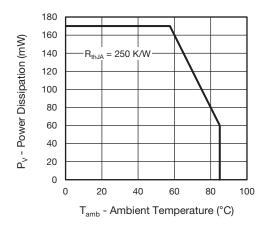


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

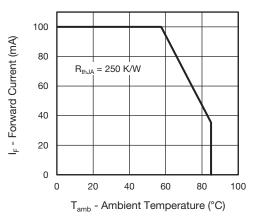


Fig. 2 - Forward Current Limit vs. Ambient Temperature

BASIC CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	I _F = 100 mA, t _p = 20 ms	V _F	-	1.4	1.8	V
	I _F = 1 A, t _p = 100 μs	V _F	-	2.5	-	V
Temperature coefficient of V _F	I _F = 100 mA	TK _{VF}	-	-0.7	-	mV/K
Reverse current		I _R	Not designed for reverse operation		μA	
Junction capacitance	$V_{R} = 0 V, f = 1 MHz, E = 0 mW/cm^{2}$	CJ	-	55	-	pF
De die at interneite	I _F = 100 mA, t _p = 20 ms	l _e	75	145	215	mW/sr
Radiant intensity	I _F = 1 A, t _p = 100 μs	l _e	-	1000	-	mW/sr
Radiant power	I _F = 100 mA, t _p = 20 ms	фе	-	55	-	mW
Temperature coefficient of radiant power	I _F = 100 mA	ΤKφ _e	-	-0.2	-	%/K
Angle of half intensity		φ	-	± 10	-	deg
Peak wavelength	I _F = 100 mA	λρ	920	940	960	nm
Spectral bandwidth	I _F = 100 mA	Δλ	-	50	-	nm
Temperature coefficient of λ_p	I _F = 100 mA	ΤΚλ _p	-	0.25	-	nm/K
Rise time	I _F = 100 mA, 10 % to 90 %	t _r	-	10	-	ns
Fall time	I _F = 100 mA, 10 % to 90 %	t _f	-	10	-	ns

2



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BASIC CHARACTERISTICS (Tamb = 25 °C, unless otherwise specified)

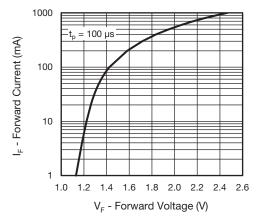


Fig. 3 - Forward Current vs. Forward Voltage

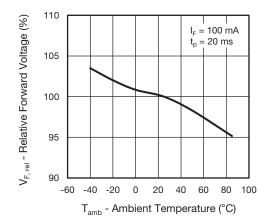


Fig. 4 - Relative Forward Voltage vs. Ambient Temperature

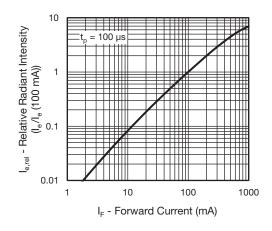


Fig. 5 - Relative Radiant Intensity vs. Forward Current

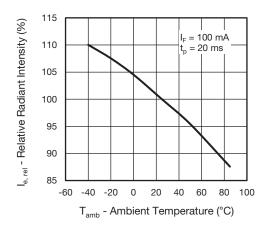


Fig. 6 - Relative Radiant Intensity vs. Ambient Temperature

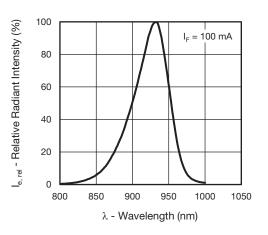


Fig. 7 - Relative Radiant Intensity vs. Wavelength

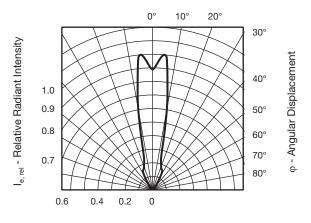


Fig. 8 - Relative Radiant Intensity vs. Angular Displacement

Rev. 1.0, 08-Nov-17

3 I questions, contact: emittertechsupport@ Document Number: 84583

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SOLDER PROFILE

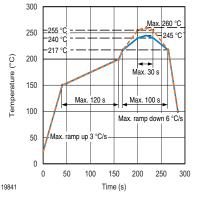


Fig. 9 - Lead (Pb)-free Reflow Solder Profile According to J-STD-020

FLOOR LIFE

DRYPACK

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label:

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during

transportation and storage. Each bag contains a desiccant.

Floor life: 4 weeks

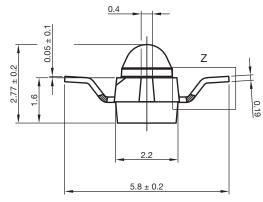
Conditions: T_{amb} < 30 °C, RH < 60 %

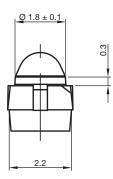
Moisture sensitivity level 2a, according to J-STD-020.

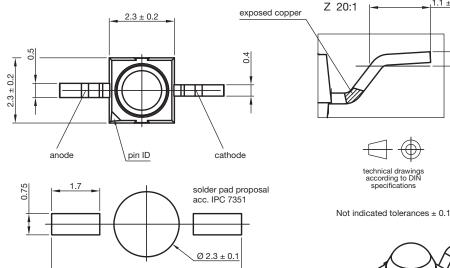
DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions 192 h at 40 °C (+ 5 °C), RH < 5 %.

PACKAGE DIMENISONS in millimeters: VSMY2940RGX01







Drawing-No.: 6.544-5391.03-4 Issue: 2; 19.09.14

6.7

 1.1 ± 0.1

0.254



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4

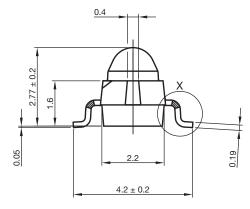
Document Number: 84583

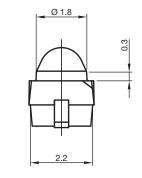
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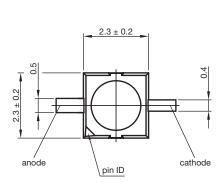
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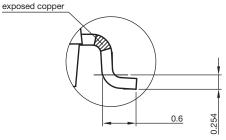
PACKAGE DIMENSIONS in millimeters: VSMY2940GX01





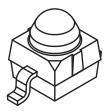
X 20:1







Not indicated tolerances ± 0.1



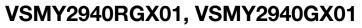
Drawing-No.: 6.544-5383.03-4 Issue: 2; 19.09.14

2.45 5.15

solder pad proposal acc. IPC 7351

0.75

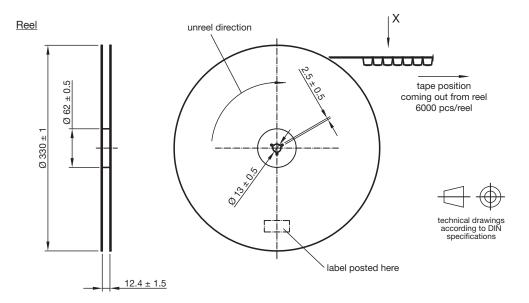
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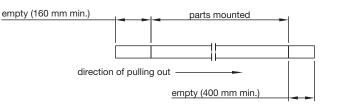
TAPING AND REEL DIMENSIONS in millimeters: VSMY2940RGX01

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Leader and trailer tape

VISHAY

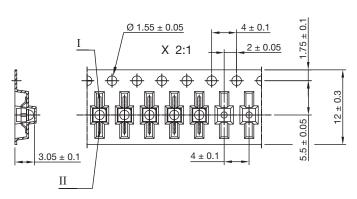


Device Lead I Lead II VEMT2000 VEMT2500 Collector Emitter

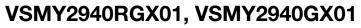
Terminal position in tape

Cathode	Anode	
1		
Anodo	Cathode	
Anoue	Calloue	
	Cathode - Anode	

Drawing-No.: 9.800-5100.01-4 Issue: 4; 19.09.14



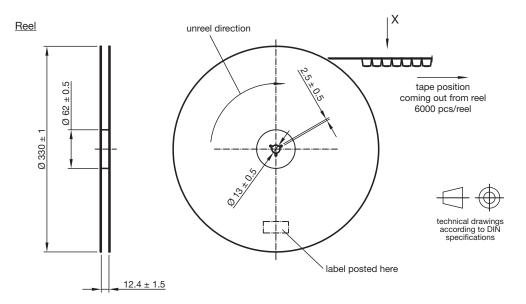
6



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TAPING AND REEL DIMENSIONS in millimeters: VSMY2940GX01

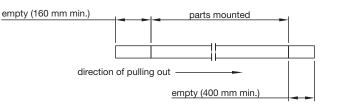
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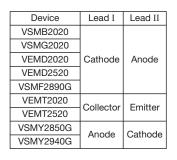


Leader and trailer tape

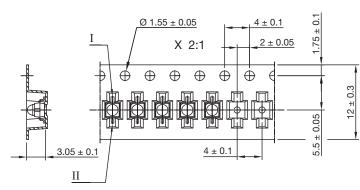
Terminal position in tape

/ISHAY





Drawing-No.: 9.800-5091.01-4 Issue: 5; 19.09.14



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